

1. Product Features

1.1 Electrical features

- $V_{CES}=1200V$
- $I_{C\ nom}=50A / I_{CRM}=100A$
- Low switching losses
- Low inductance
- Fast switching and short tail current
- Integrated NTC temperature sensor
- High power and thermal cycling capability



Figure1 IGBT Module

1.2 Mechanical features

- Integrated NTC temperature sensor
- High power and thermal cycling capability
- Al_2O_3 substrate with low thermal resistance

2. Typical Applications

- Inverter for motor drive
- AC and DC servo drive amplifier
- power supply

3. Description

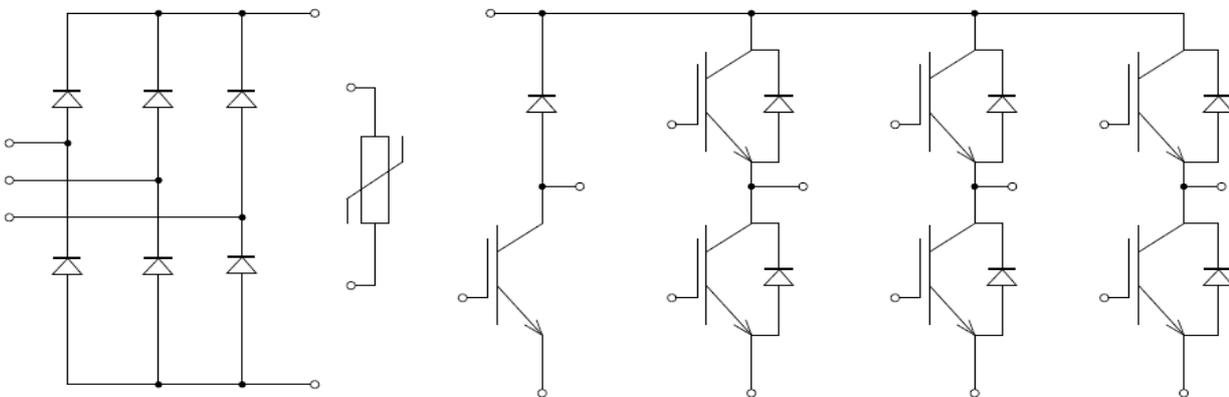


Figure 2 3 Phase Bridge +Rectifier+Brake

4. IGBT, Inverter

4.1 Maximum Rated Values

Parameter	Note or test condition	Symbol	Values	Unit
Collector-emitter voltage 集电极—发射极间电压	$T_{vj} = 25^{\circ}\text{C}$	V_{CES}	1200	V
Continuous DC collector current 连续集电极电流	$T_C = 100^{\circ}\text{C}, T_{vj, max} = 150^{\circ}\text{C}$	$I_{C nom}$	50	A
Repetitive peak collector current 集电极峰值电流	$t_P = 1 \text{ ms}$	I_{CRM}	100	A
Total power dissipation 总功率损耗	$T_C = 25^{\circ}\text{C}, T_{vj, max} = 175^{\circ}\text{C}$	P_{tot}	180	W
Gate-emitter peak voltage 栅极—发射极峰值电压		V_{GES}	+/- 20	V

4.2 Characteristic value

Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Collector-emitter saturation voltage 集电极—发射极饱和电压	$I_C = 50 \text{ A}, V_{GE} = 15 \text{ V}$	$V_{CE, sat}$		$T_{vj} = 25^{\circ}\text{C}$	1.7	V
				$T_{vj} = 125^{\circ}\text{C}$	1.9	V
				$T_{vj} = 150^{\circ}\text{C}$	2.0	V
Gate threshold voltage 栅极阈值电压	$I_C = 0.25 \text{ mA}, V_{CE} = V_{GE}, T_{vj} = 25^{\circ}\text{C}$	$V_{GE, th}$	5.0	5.8	6.5	V
Gate charge 栅极电荷	$V_{GE} = -15 \text{ V} \dots +15 \text{ V}$	Q_G		0.44		μC
Internal gate resistor 内部栅极电阻	$T_{vj} = 25^{\circ}\text{C}$	R_{Gint}		2.2		Ω
Input capacitance 输入电容	$f=1\text{MHz}, T_{vj}=25^{\circ}\text{C}, V_{CE}=25\text{V}, V_{GE}=0\text{V}$	C_{ies}		6.15		nF
Reverse transfer capacitance 反向传输电容	$f=1\text{MHz}, T_{vj}=25^{\circ}\text{C}, V_{CE}=25\text{V}, V_{GE}=0\text{V}$	C_{res}		0.08		nF
Collector-emitter cut-off current 集电极-发射极截止电流	$V_{CE} = 1200 \text{ V}, V_{GE} = 0 \text{ V}, T_{vj} = 25^{\circ}\text{C}$	I_{CES}			1	mA
Gate-emitter leakage current 栅极-发射极漏电流	$V_{CE} = 0 \text{ V}, V_{GE} = 20 \text{ V}, T_{vj} = 25^{\circ}\text{C}$	I_{GES}			100	nA
Turn-on delay time, inductive load 开通延迟时间	$I_C = 50 \text{ A}, V_{CE} = 600 \text{ V}$ $V_{GE} = +15/-15 \text{ V}$ $R_{G, on} = 6.8 \Omega$	$t_{d, on}$		$T_{vj} = 25^{\circ}\text{C}$	0.038	μs
				$T_{vj} = 125^{\circ}\text{C}$	0.036	μs
				$T_{vj} = 150^{\circ}\text{C}$	0.037	μs
Rise time, inductive load 上升时间	$I_C = 50 \text{ A}, V_{CE} = 600 \text{ V}$ $V_{GE} = +15/-15 \text{ V}$ $R_{G, on} = 6.8 \Omega$	t_r		$T_{vj} = 25^{\circ}\text{C}$	0.028	μs
				$T_{vj} = 125^{\circ}\text{C}$	0.029	μs
				$T_{vj} = 150^{\circ}\text{C}$	0.030	μs

(table continues...) 待续

Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Turn-off delay time, inductive load 关断延迟时间	$I_C = 50A, V_{CE} = 600V$ $V_{GE} = +15/-15V$ $R_{G,off} = 6.8\Omega$	$T_{vj} = 25^\circ C$ $T_{vj} = 125^\circ C$ $T_{vj} = 150^\circ C$	$t_{d,off}$		0.157	us
					0.188	us
					0.196	us
Fall time, inductive load 下降时间	$I_C = 50A, V_{CE} = 600V$ $V_{GE} = +15/-15V$ $R_{G,off} = 6.8\Omega$	$T_{vj} = 25^\circ C$ $T_{vj} = 125^\circ C$ $T_{vj} = 150^\circ C$	t_f		0.163	us
					0.285	us
					0.311	us
Turn-on energy loss per pulse 开通损耗能量	$I_C = 50A, V_{CE} = 600V, L_s = 35nH$ $V_{GE} = +15/-15V, di/dt = 1350A/\mu s$ $R_{G,on} = 6.8\Omega (T_{vj} = 150^\circ C)$	$T_{vj} = 25^\circ C$ $T_{vj} = 125^\circ C$ $T_{vj} = 150^\circ C$	E_{on}		3.39	mJ
					4.24	mJ
					4.68	mJ
Turn-off energy loss per pulse 关断损耗能量	$I_C = 50A, V_{CE} = 600V, L_s = 35nH$ $V_{GE} = +15/-15V, dv/dt = 5800V/\mu s$ $R_{G,off} = 6.8\Omega (T_{vj} = 150^\circ C)$	$T_{vj} = 25^\circ C$ $T_{vj} = 125^\circ C$ $T_{vj} = 150^\circ C$	E_{off}		3.32	mJ
					4.26	mJ
					5.17	mJ
SC data 短路数据	$V_{GE} \leq 15V, V_{CC} = 600V, t_P \leq 8\mu s, T_{vj} = 150^\circ C,$ $C_{GE} = 0.0\mu F, V_{CEmax} = V_{CES} - L_{sCE} \cdot di/dt$		I_{sc}		300	A
Thermal resistance, junction to case 结-外壳热阻	Per IGBT		$R_{th,JH}$			0.72 K/W

5. Diode, Inverter

5.1 Maximum Rated Values

Parameter	Note or test condition	Symbol	Values	Unit
Repetitive peak reverse voltage 反向重复峰值电压	$T_{vj} = 25^\circ C$	V_{RRM}	1200	V
Continuous DC forward current 连续正向直流电流		I_F	50	A
Repetitive peak forward current 正向重复峰值电流	$t_P = 1\text{ ms}$	I_{FRM}	100	A

5.2 Characteristic value

Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Forward voltage 正向电压	$I_F = 50\text{ A}, V_{GE} = 0\text{ V}$	V_F		2.35	V	
				2.50	V	
				2.50	V	

(table continues...) 待续

Parameter	Note or test condition	Symbol	Values			Unit	
			Min.	Typ.	Max.		
Peak reverse recovery current 反向恢复峰值电流	$I_F = 50A, V_R = 600V$ $V_{GE} = -15V, -di_F/dt = 2060 A/\mu s$ ($T_{vj}=150^\circ C$)	$T_{vj} = 25^\circ C$ $T_{vj} = 125^\circ C$ $T_{vj} = 150^\circ C$	I_{RM}		61 76 80	A A A	
Recovered charge 恢复电荷	$I_F = 50A, V_R = 600V$ $V_{GE} = -15V, -di_F/dt = 2060 A/\mu s$ ($T_{vj}=150^\circ C$)	$T_{vj} = 25^\circ C$ $T_{vj} = 125^\circ C$ $T_{vj} = 150^\circ C$		Q_r		3.30 5.06 6.05	μC μC μC
Reverse recovery energy 反向恢复损耗 (每脉冲)	$I_F = 50A, V_R = 600V$ $V_{GE} = -15V, -di_F/dt = 2060 A/\mu s$ ($T_{vj}=150^\circ C$)	$T_{vj} = 25^\circ C$ $T_{vj} = 125^\circ C$ $T_{vj} = 150^\circ C$			E_{rec}		0.79 1.57 2.03
Thermal resistance, junction to case 结—外壳热阻	Per diode		$R_{th,JH}$				

6. Diode, Rectifier

6.1 Maximum Rated Values

Parameter	Note or test condition	Symbol	Values	Unit
Repetitive peak reverse voltage 反向重复峰值电压	$T_{vj} = 25^\circ C$	V_{RRM}	1600	V
Average Rectified Output current 整流器输出均方根电流	$V_F = 1.2, T_{vj} = 150^\circ C$	I_F	50	A
Surge forward current 正向浪涌电流	$t_p = 10 ms, T_{vj} = 150^\circ C$	I_{FSM}	350	A
I^2t - value I^2t -值	$t_p = 10 ms, T_{vj} = 150^\circ C$	I^2t	1225	A^2s

6.2 Characteristic value

Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Forward voltage 正向电压	$T_{vj} = 150^\circ C, I_F = 50 A$	V_F		1.1		V
Reverse current 反向电流	$T_{vj} = 150^\circ C, V_R = 1600 V$	I_R		1		mA
Thermal resistance, junction to case 结—外壳热阻	Per diode	$R_{th,JH}$?	K/W

7. IGBT, Brake-Chopper

7.1 Maximum Rated Values

Parameter	Note or test condition	Symbol	Values	Unit
Collector-emitter voltage 集电极—发射极间电压	$T_{vj} = 25^{\circ}\text{C}$	V_{CES}	1200	V
Continuous DC collector current 连续集电极电流	$T_C = 100^{\circ}\text{C}, T_{vj} \text{ max} = 150^{\circ}\text{C}$	$I_{C \text{ nom}}$	50	A
Repetitive peak collector current 集电极峰值电流	$t_P = 1 \text{ ms}$	I_{CRM}	100	A
Gate-emitter peak voltage 栅极—发射极峰值电压		V_{GES}	+/- 20	V

7.2 Characteristic value

Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Collector-emitter saturation voltage 集电极—发射极饱和电压	$I_C = 50 \text{ A}, V_{GE} = 15 \text{ V}$	$V_{CE, \text{sat}}$		$T_{vj} = 25^{\circ}\text{C}$	1.7	V
				$T_{vj} = 125^{\circ}\text{C}$	1.9	V
				$T_{vj} = 150^{\circ}\text{C}$	2.0	V
Gate threshold voltage 栅极阈值电压	$I_C = 0.25 \text{ mA}, V_{CE} = V_{GE}, T_{vj} = 25^{\circ}\text{C}$	$V_{GE, \text{th}}$	5.0	5.8	6.5	V
Gate charge 栅极电荷	$V_{GE} = -15 \text{ V} \dots +15 \text{ V}$	Q_G		0.44		μC
Internal gate resistor 内部栅极电阻	$T_{vj} = 25^{\circ}\text{C}$	$R_{G \text{ int}}$		2.2		Ω
Input capacitance 输入电容	$f = 1 \text{ MHz}, T_{vj} = 25^{\circ}\text{C}, V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}$	C_{ies}		6.15		nF
Reverse transfer capacitance 反向传输电容	$f = 1 \text{ MHz}, T_{vj} = 25^{\circ}\text{C}, V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}$	C_{res}		0.08		nF
Collector-emitter cut-off current 集电极-发射极截止电流	$V_{CE} = 1200 \text{ V}, V_{GE} = 0 \text{ V}, T_{vj} = 25^{\circ}\text{C}$	I_{CES}			1	mA
Gate-emitter leakage current 栅极-发射极漏电流	$V_{CE} = 0 \text{ V}, V_{GE} = 20 \text{ V}, T_{vj} = 25^{\circ}\text{C}$	I_{GES}			100	nA
Turn-on delay time, inductive load 开通延迟时间	$I_C = 50 \text{ A}, V_{CE} = 600 \text{ V}$ $V_{GE} = +15/-15 \text{ V}$ $R_{G, \text{on}} = 10 \Omega$	$t_{d, \text{on}}$		$T_{vj} = 25^{\circ}\text{C}$	0.063	μs
				$T_{vj} = 125^{\circ}\text{C}$	0.067	μs
				$T_{vj} = 150^{\circ}\text{C}$	0.073	μs
Rise time, inductive load 上升时间	$I_C = 50 \text{ A}, V_{CE} = 600 \text{ V}$ $V_{GE} = +15/-15 \text{ V}$ $R_{G, \text{on}} = 10 \Omega$	t_r		$T_{vj} = 25^{\circ}\text{C}$	0.037	μs
				$T_{vj} = 125^{\circ}\text{C}$	0.042	μs
				$T_{vj} = 150^{\circ}\text{C}$	0.044	μs

(table continues...) 待续

Parameter	Note or test condition		Symbol	Values			Unit
				Min.	Typ.	Max.	
Turn-off delay time, inductive load 关断延迟时间	$I_C = 50A, V_{CE} = 600V$ $V_{GE} = +15/-15V$ $R_{G,off} = 10\Omega$	$T_{vj} = 25^\circ C$	$t_{d,off}$		0.167		us
		$T_{vj} = 125^\circ C$			0.200		us
		$T_{vj} = 150^\circ C$			0.207		us
Fall time, inductive load 下降时间	$I_C = 50A, V_{CE} = 600V$ $V_{GE} = +15/-15V$ $R_{G,off} = 10\Omega$	$T_{vj} = 25^\circ C$	t_f		0.245		us
		$T_{vj} = 125^\circ C$			0.310		us
		$T_{vj} = 150^\circ C$			0.081		us
Turn-on energy loss per pulse 开通损耗能量	$I_C = 50A, V_{CE} = 600V, L_s=30nH$ $V_{GE} = +15/-15V, di/dt = 920A/\mu s$ $R_{G,on} = 10\Omega (T_{vj} = 150^\circ C)$	$T_{vj} = 25^\circ C$	E_{on}		4.53		mJ
		$T_{vj} = 125^\circ C$			5.77		mJ
		$T_{vj} = 150^\circ C$			6.07		mJ
Turn-off energy loss per pulse 关断损耗能量	$I_C = 50A, V_{CE} = 600V, L_s=30nH$ $V_{GE} = +15/-15V, dv/dt = 5930V/\mu s$ $R_{G,off} = 10\Omega (T_{vj} = 150^\circ C)$	$T_{vj} = 25^\circ C$	E_{off}		3.10		mJ
		$T_{vj} = 125^\circ C$			4.81		mJ
		$T_{vj} = 150^\circ C$			5.02		mJ
SC data 短路数据	$V_{GE} \leq 15V, V_{CC} = 600V, t_P \leq 8\mu s, T_{vj} = 150^\circ C,$ $C_{GE} = 0.0\mu F, V_{CEmax} = V_{CES} - L_{sCE} \cdot di/dt$		I_{sc}		300		A
Thermal resistance, junction to case 结-外壳热阻	Per IGBT		$R_{th,JH}$			0.90	K/W

8. Diode, Brake-Chopper

8.1 Maximum Rated Values

Parameter	Note or test condition	Symbol	Values	Unit
Repetitive peak reverse voltage 反向重复峰值电压	$T_{vj} = 25^\circ C$	V_{RRM}	1200	V
Continuous DC forward current 连续正向直流电流		I_F	50	A
Repetitive peak forward current 正向重复峰值电流	$t_P = 1ms$	I_{FRM}	100	A

8.2 Characteristic value

Parameter	Note or test condition		Symbol	Values			Unit
				Min.	Typ.	Max.	
Forward voltage 正向电压	$I_F = 50A, V_{GE} = 0V$	$T_{vj} = 25^\circ C$	V_F		2.35		V
		$T_{vj} = 125^\circ C$			2.50		V
		$T_{vj} = 150^\circ C$			2.50		V

(table continues...) 待续

Parameter	Note or test condition		Symbol	Values			Unit
				Min.	Typ.	Max.	
Peak reverse recovery current 反向恢复峰值电流	I _F = 50A, V _R = 600V V _{GE} = -15V, - di _F /dt = 75 A/μs (T _{vj} =150°C)	T _{vj} = 25°C	I _{RM}		20.68		A
		T _{vj} = 125°C			22.10		A
		T _{vj} = 150°C			23.85		A
Recovered charge 恢复电荷	I _F = 50A, V _R = 600V V _{GE} = -15V, - di _F /dt = 75 A/μs (T _{vj} =150°C)	T _{vj} = 25°C	Q _r		2.54		μC
		T _{vj} = 125°C			4.52		μC
		T _{vj} = 150°C			5.27		μC
Reverse recovery energy 反向恢复损耗 (每脉冲)	I _F = 50A, V _R = 600V V _{GE} = -15V, - di _F /dt = 75 A/μs (T _{vj} =150°C)	T _{vj} = 25°C	E _{rec}		0.64		mJ
		T _{vj} = 125°C			1.42		mJ
		T _{vj} = 150°C			1.67		mJ
Thermal resistance, junction to case 结-外壳热阻	Per diode		R _{th,JH}			1.208	K/W

9. NTC-Thermistor

9.1 Characteristic value

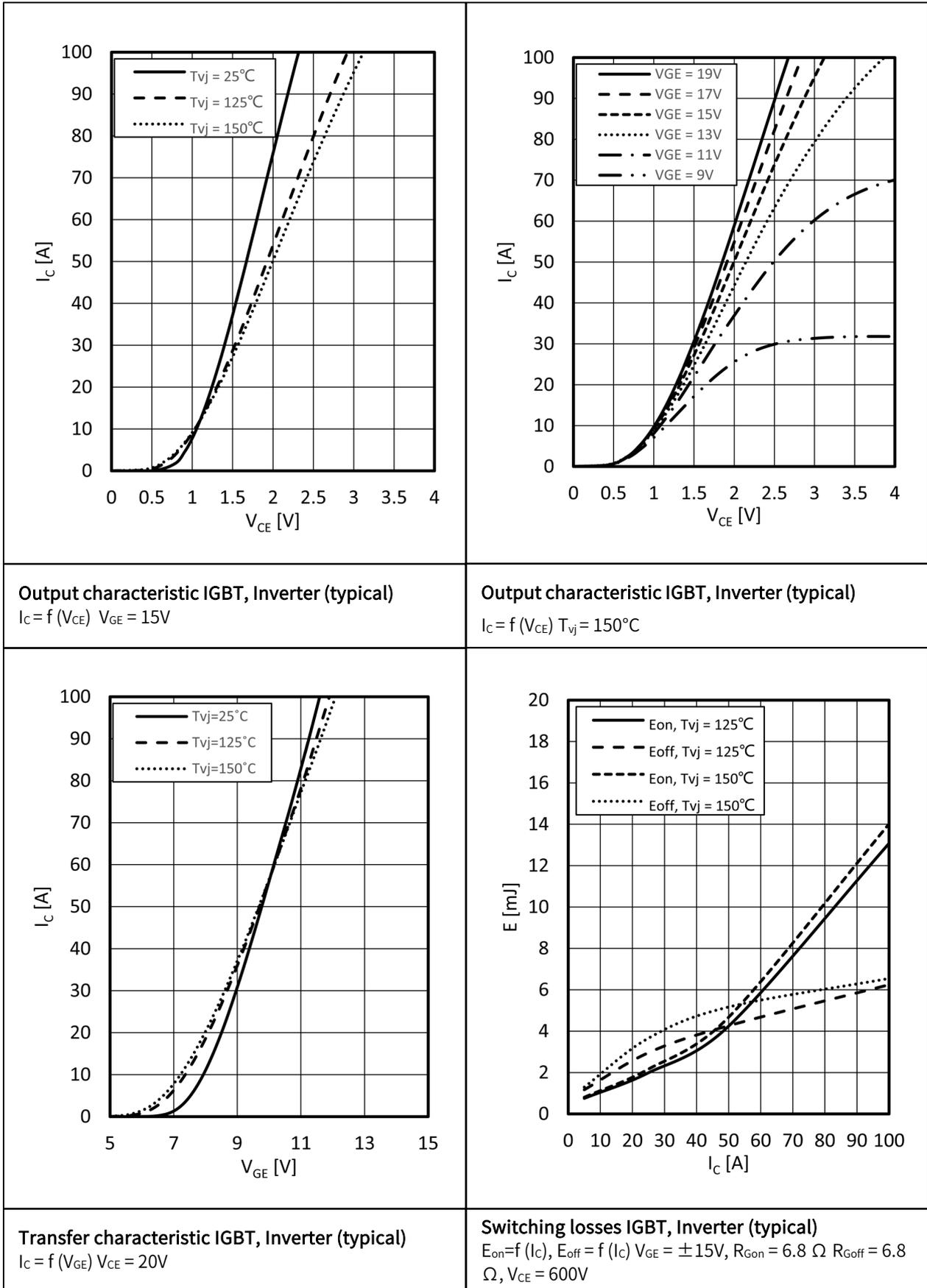
Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Rated resistance 额定电阻值	T _C = 25°C	R ₂₅		5.00		KΩ
Power dissipation 耗散功耗	T _C = 25°C	P ₂₅			20	mW
B-value B-Z 值	$R_2=R_{25}\exp[B_{25/50}(1/T_2-1/(298, 15K))]$	B ₂₅ /B ₅₀		3400		K
B-value B-Z 值	$R_2=R_{25}\exp[B_{25/75}(1/T_2-1/(298, 15K))]$	B ₂₅ /B ₇₅		3430		K
B-value B-Z 值	$R_2=R_{25}\exp[B_{25/100}(1/T_2-1/(298, 15K))]$	B ₂₅ /B ₁₀₀		3445		K

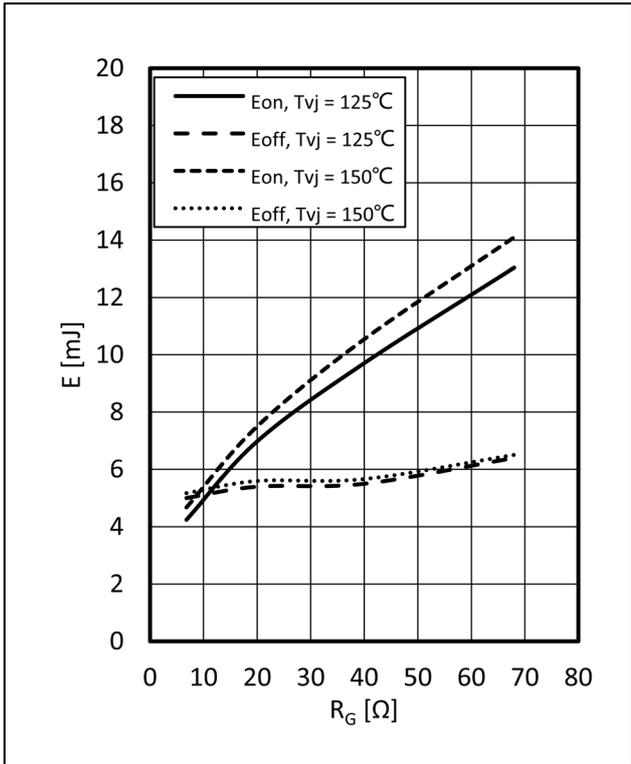
10. Module

10.1 Characteristic value

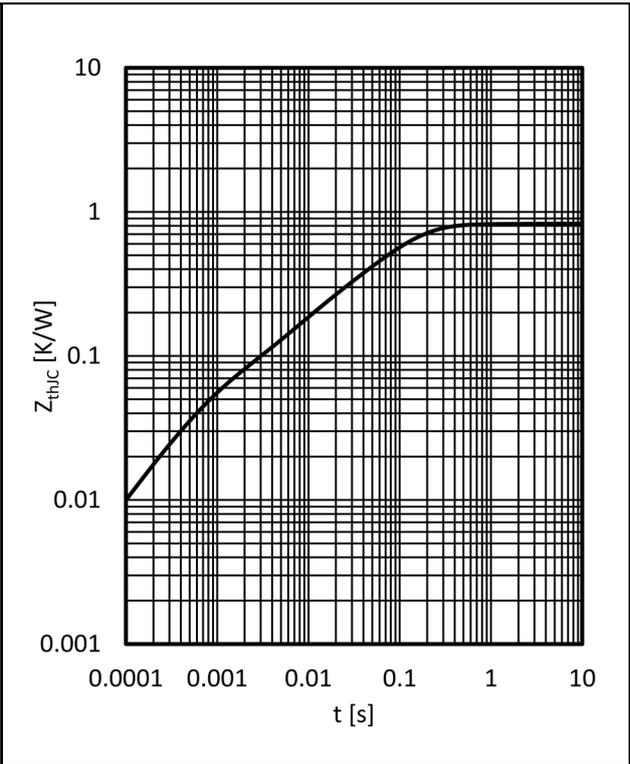
Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Isolation Voltage 隔离电压	RMS, f=50HZ,1min	V_{ISOL}			2500	V
Stray inductance module 杂散电感		L_{SCE}		30		nH
Operation Junction Temperature 结温		T_{jop}	-40		150	°C
Storage Temperature Range 存储温度范围		T_{stg}	-40		125	°C
Mounting Torque 安装扭矩	Screw M4	M	2		2.3	N.m
Weight of Module 重量		G		42		g

11. Characteristics diagrams

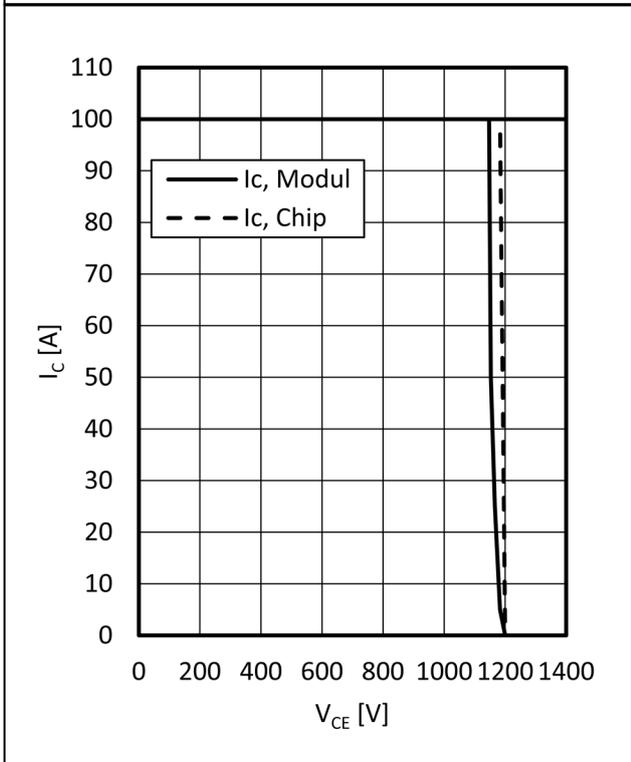




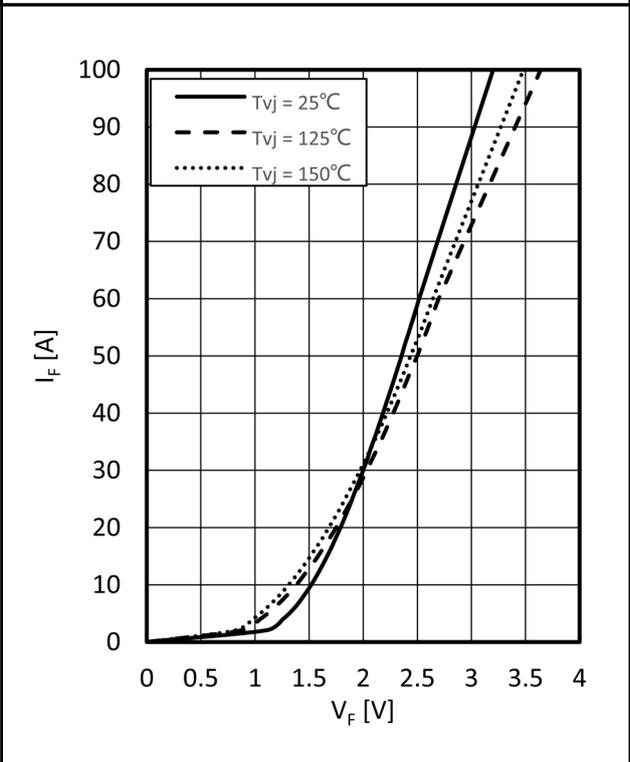
Switching losses IGBT, Inverter (typical)
 $E_{on} = f(R_G)$, $E_{off} = f(R_G)$ $V_{GE} = \pm 15V$, $I_C = 50A$, $V_{CE} = 600V$



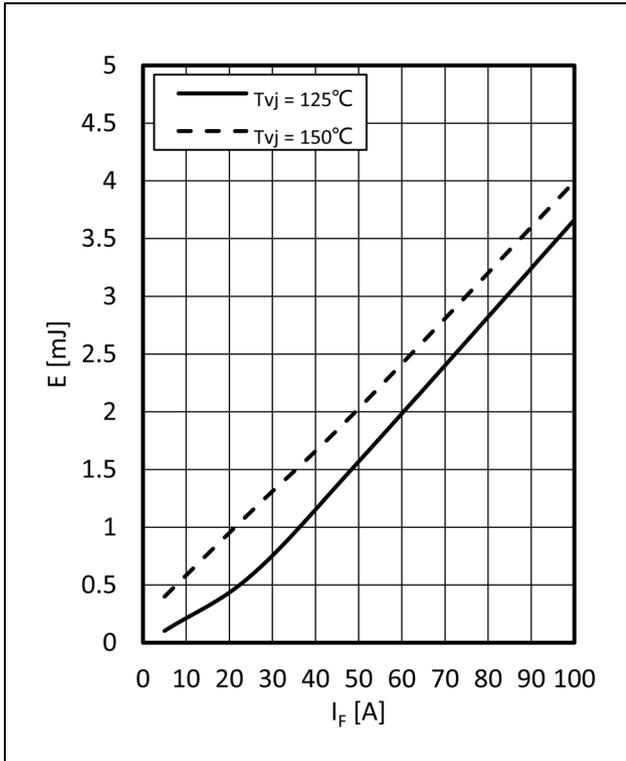
Transient thermal impedance IGBT, Inverter
 $Z_{thJC} = f(t)$



Reverse bias safe operating area IGBT, Inverter (RBSOA)
 $I_C = f(V_{CE})$ $V_{GE} = \pm 15V$ $R_{Goff} = 6.8\Omega$, $T_{vj} = 150^\circ C$

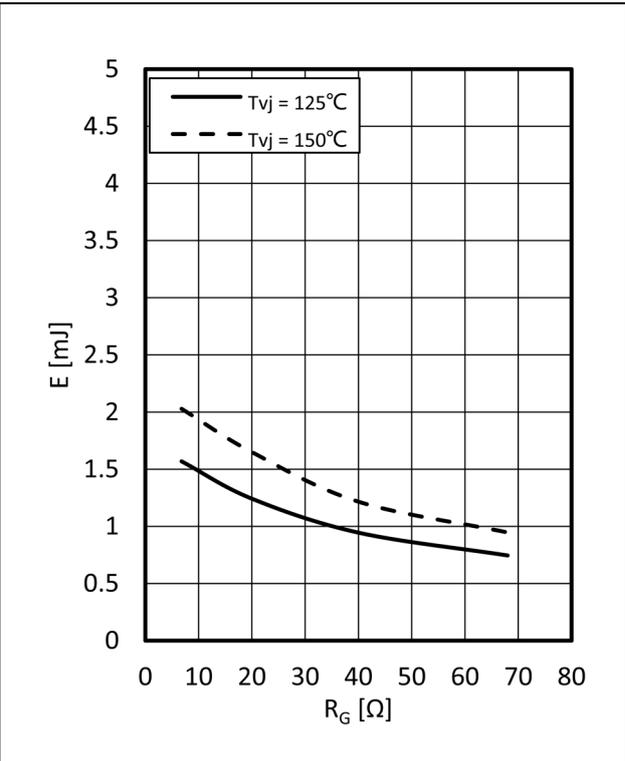


Forward characteristic of Diode, Inverter (typical)
 $I_F = f(V_F)$



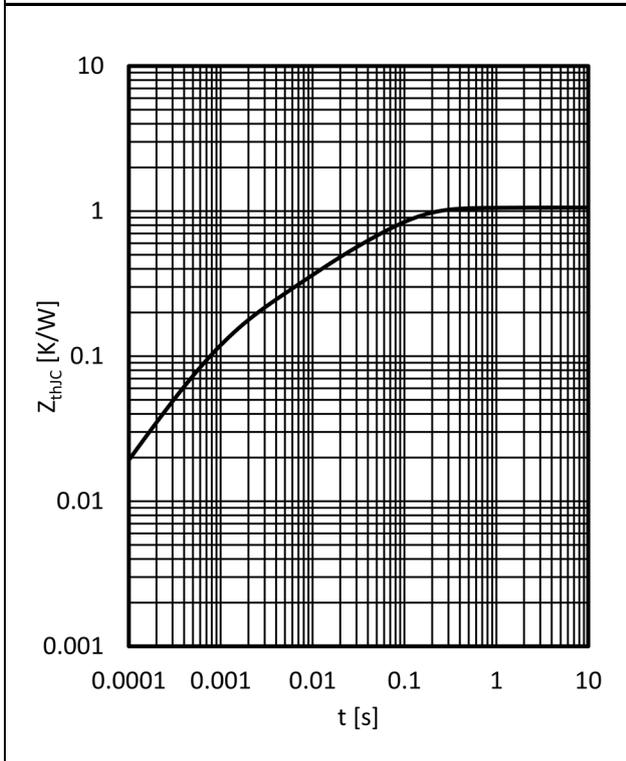
Switching losses Diode, Inverter (typical)

$E_{rec} = f(I_F) R_{Gon} = 6.8 \Omega, V_{CC} = 600V$



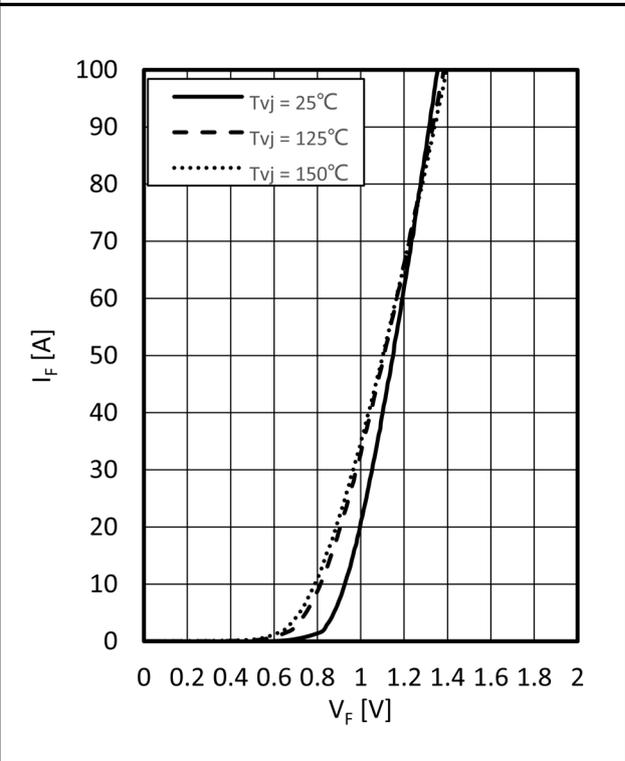
Switching losses Diode, Inverter (typical)

$E_{rec} = f(R_G) I_F = 50 A, V_{CC} = 600V$



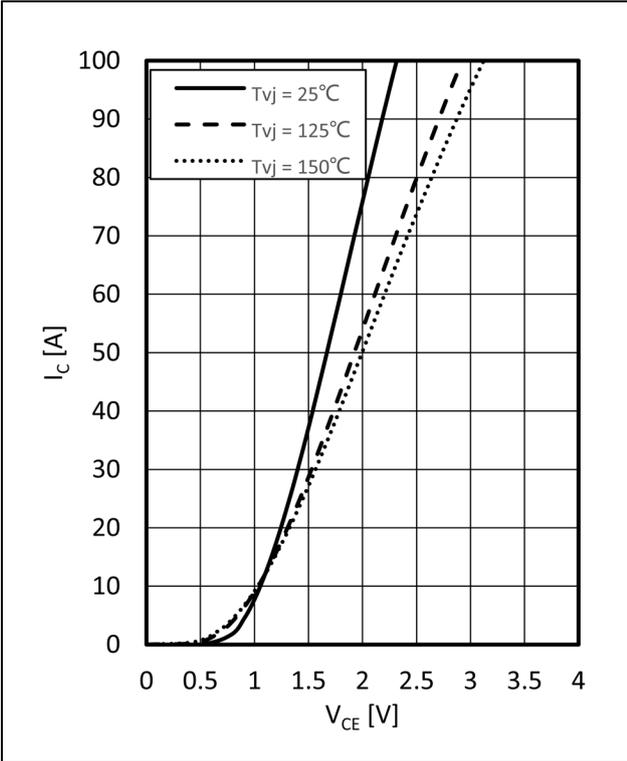
Transient thermal impedance Diode Inverter

$Z_{thJC} = f(t)$

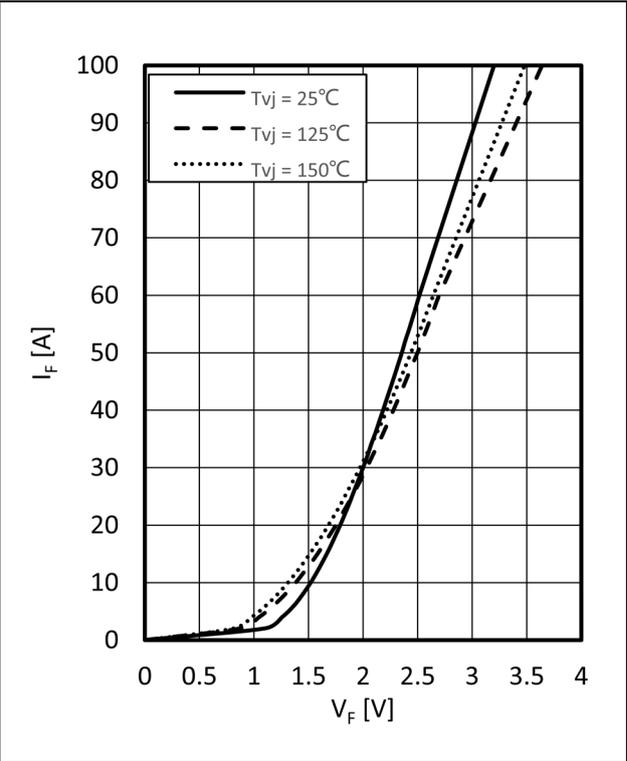


Forward characteristic of Diode, Rectifier (typical)

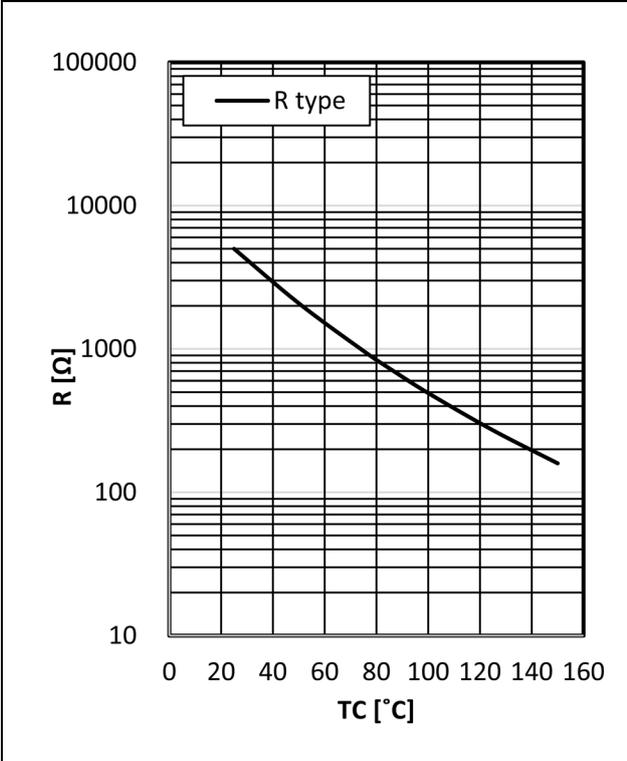
$I_F = f(V_F)$



Output characteristic IGBT, Brake-Chopper (typical)



Forward characteristic of Diode, Brake-Chopper (typical)



NTC-Thermistor-temperature characteristic (typical)

12. Circuit Diagram

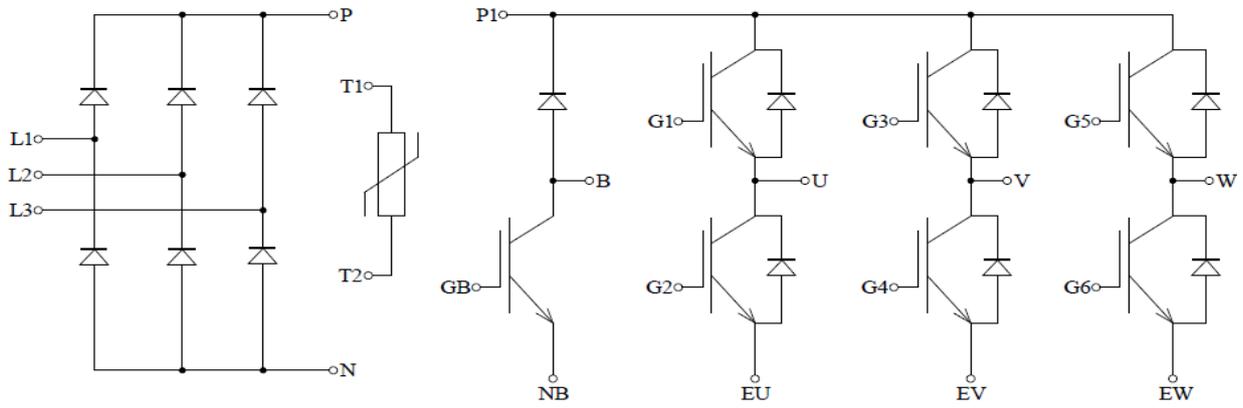


Figure 3

13. Package Outlines

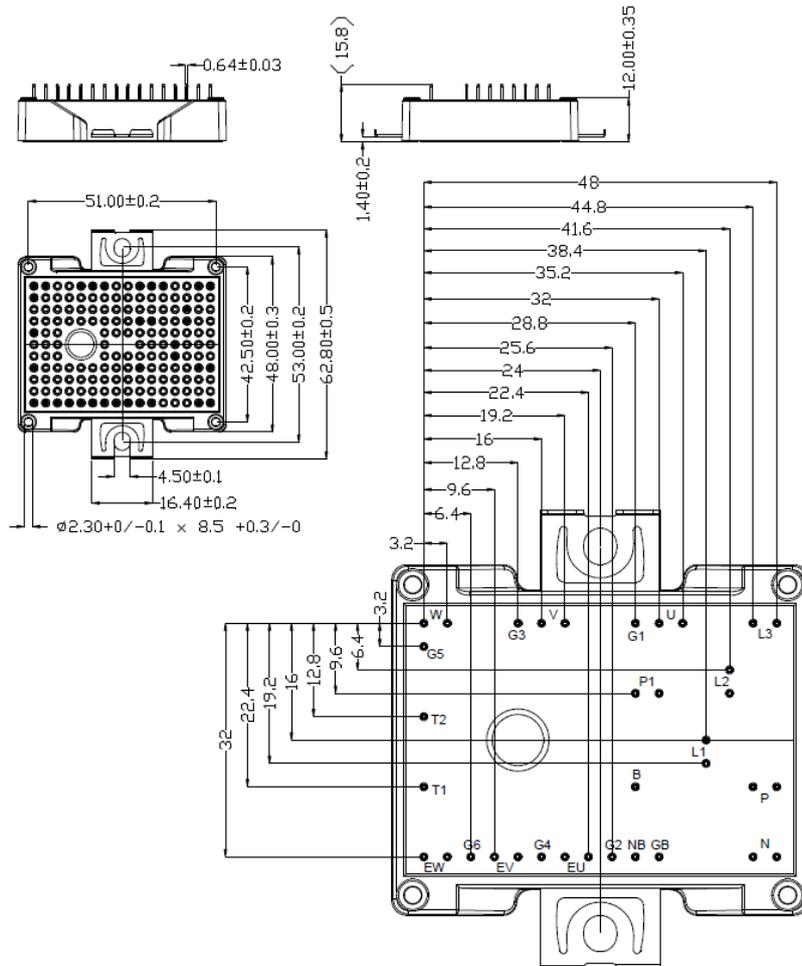


Figure 4